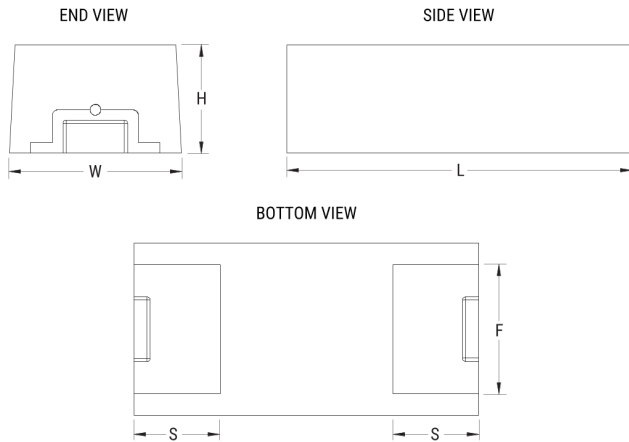


## TEFPSA31A336M8R

Aliases (FPSA31A336M8R-T&R)

F/PS, Tantalum, Polymer Tantalum, Reduced Volume, 33 uF, 20%, 10 VDC, SMD, Polymer, Molded, Low ESR, Face Down Terminals, 200 mOhms, 3216, Height Max = 1mm



Click [here](#) for the 3D model.

### Dimensions

Footprint	3216
L	3.2mm +/-0.2mm
W	1.6mm +/-0.2mm
H	0.9mm +/-0.1mm
S	0.7mm +/-0.2mm
F	1.2mm +/-0.1mm

### Packaging Specifications

Packaging T&R, 178mm

### General Information

Series	F/PS
Dielectric	Polymer Tantalum
Style	SMD Chip
Description	SMD, Polymer, Molded, Low ESR, Face Down Terminals
Features	Low ESR, Face Down Terminal
RoHS	Yes
Termination	Tin
AEC-Q200	No

### Specifications

Capacitance	33 uF
Capacitance Tolerance	20%
Voltage DC	10 VDC (105°C), 13 VDC (Surge)
Temperature Range	-55/+105°C
Rated Temperature	105°C
Dissipation Factor	6%
Failure Rate	N/A
Resistance	0.2 Ohms (100kHz)
Ripple Current	548 mAmps (25C)
Leakage Current	33 uA

单击下面可查看定价，库存，交付和生命周期等信息

[>>KEMET\(基美\)](#)